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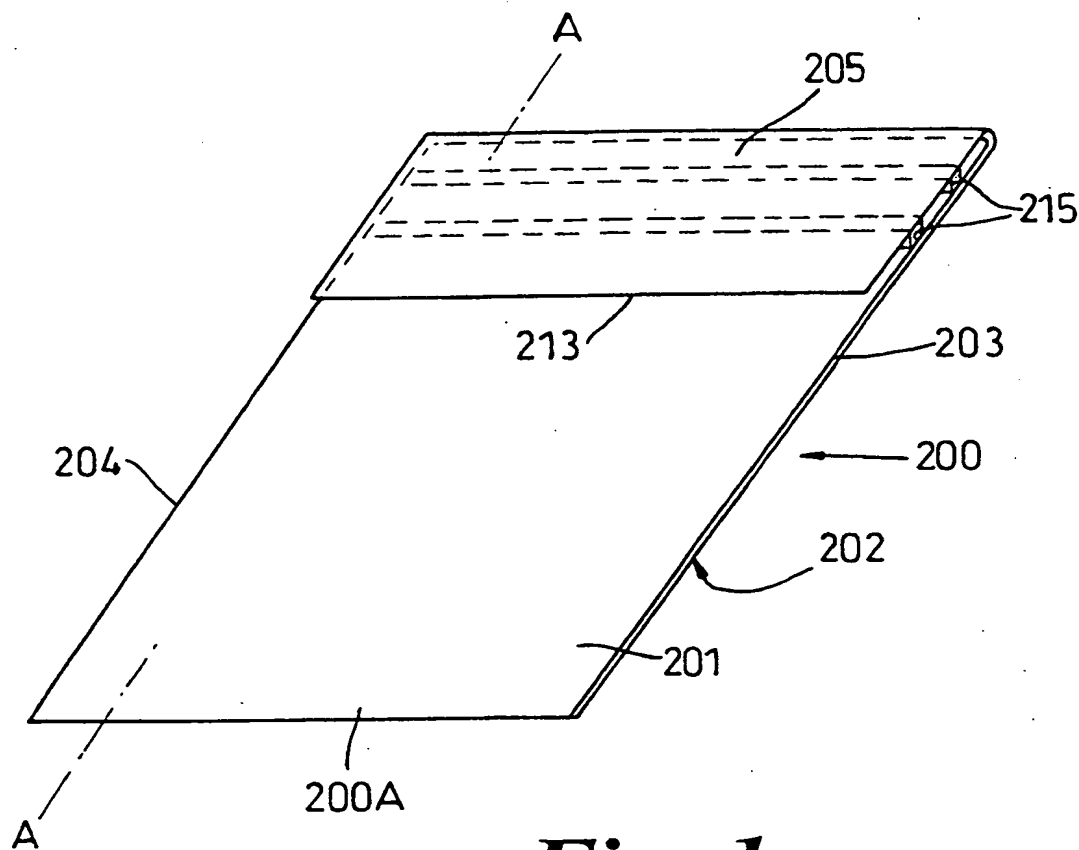


Fig. 1

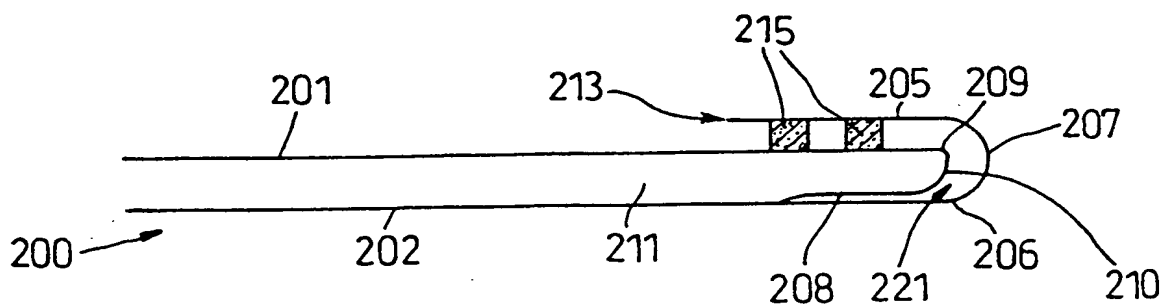


Fig. 2

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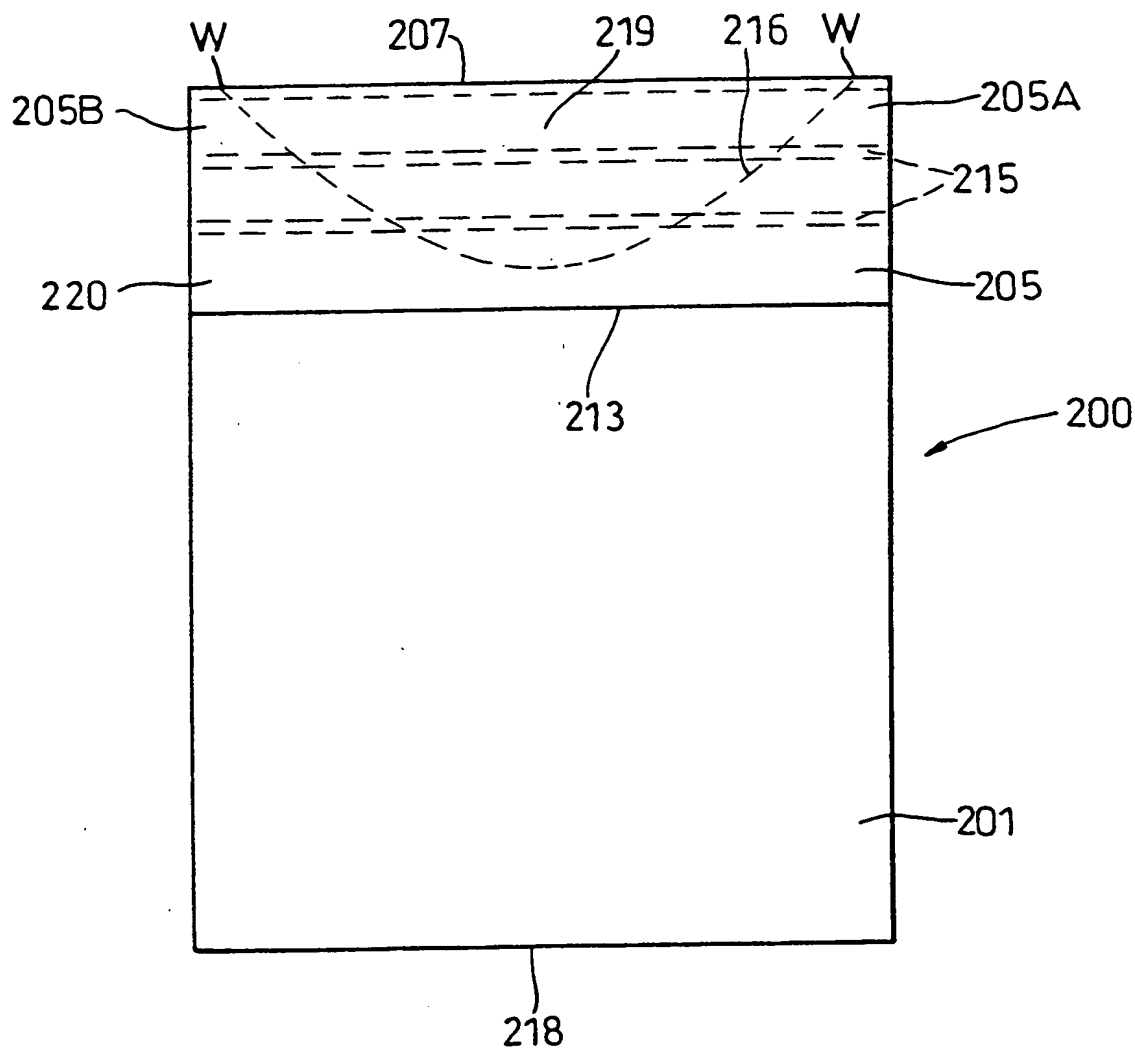
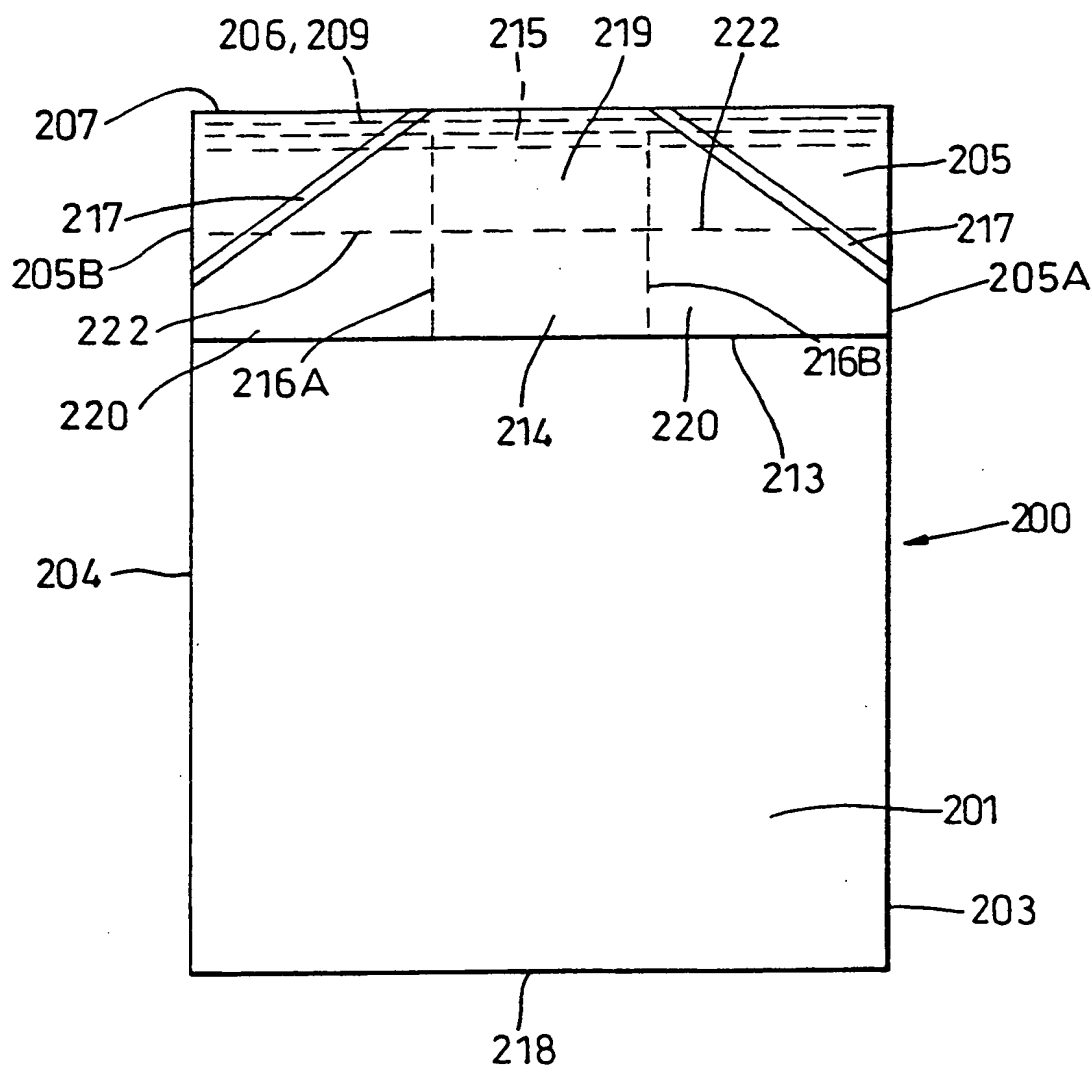


Fig. 3

SECRET



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*Fig. 5*

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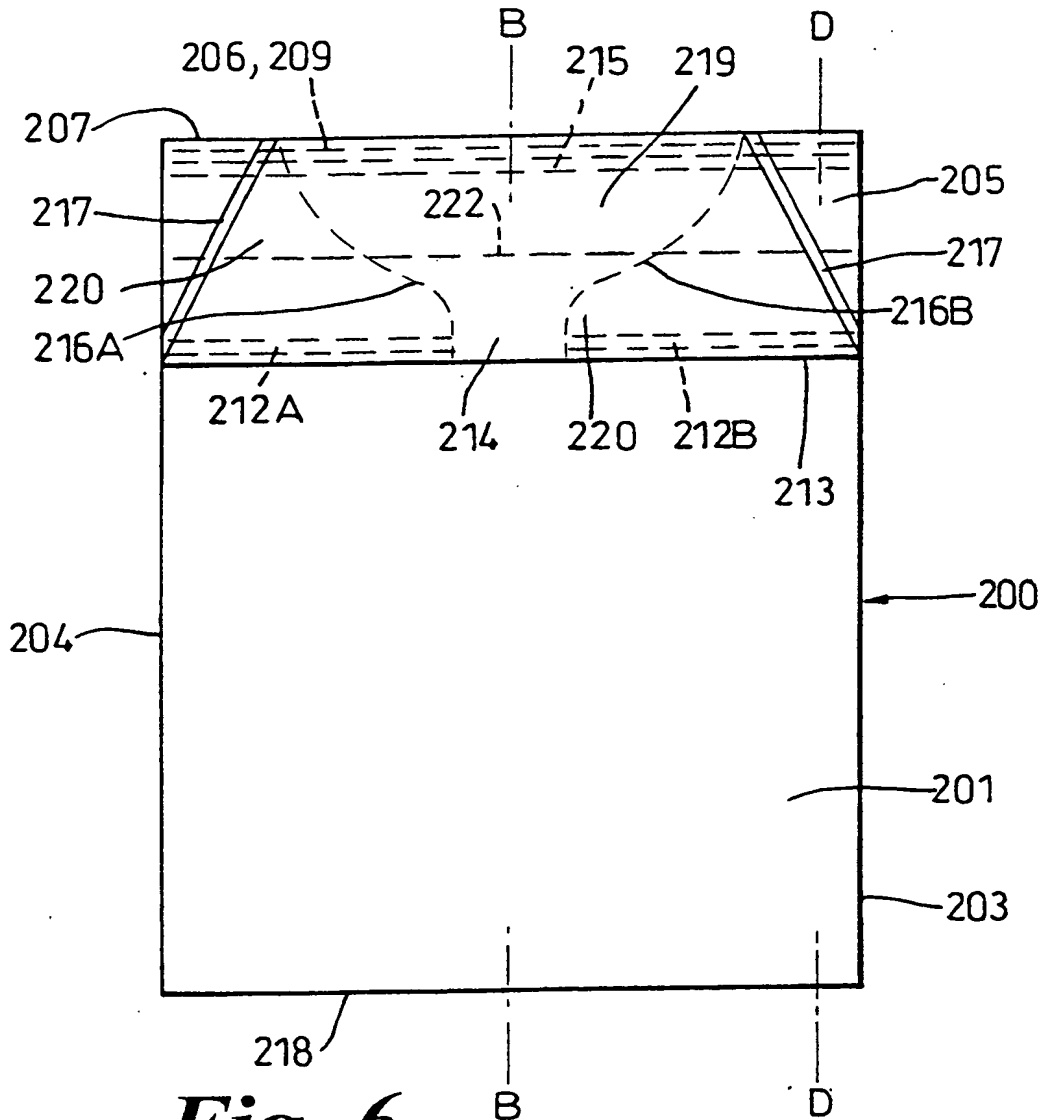


Fig. 6

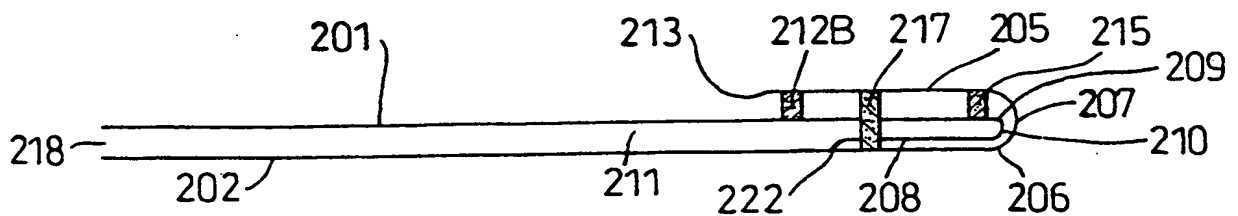


Fig. 7

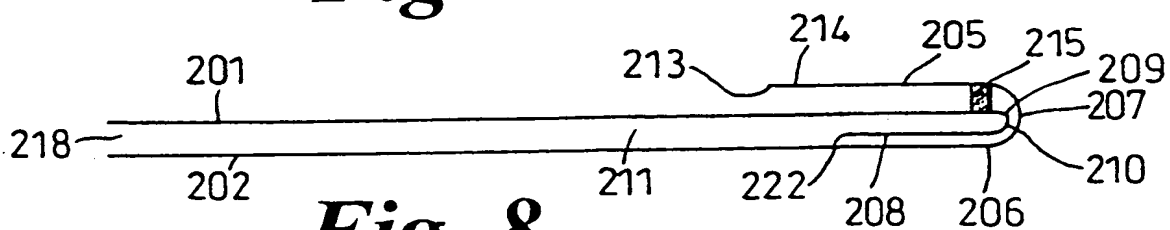


Fig. 8

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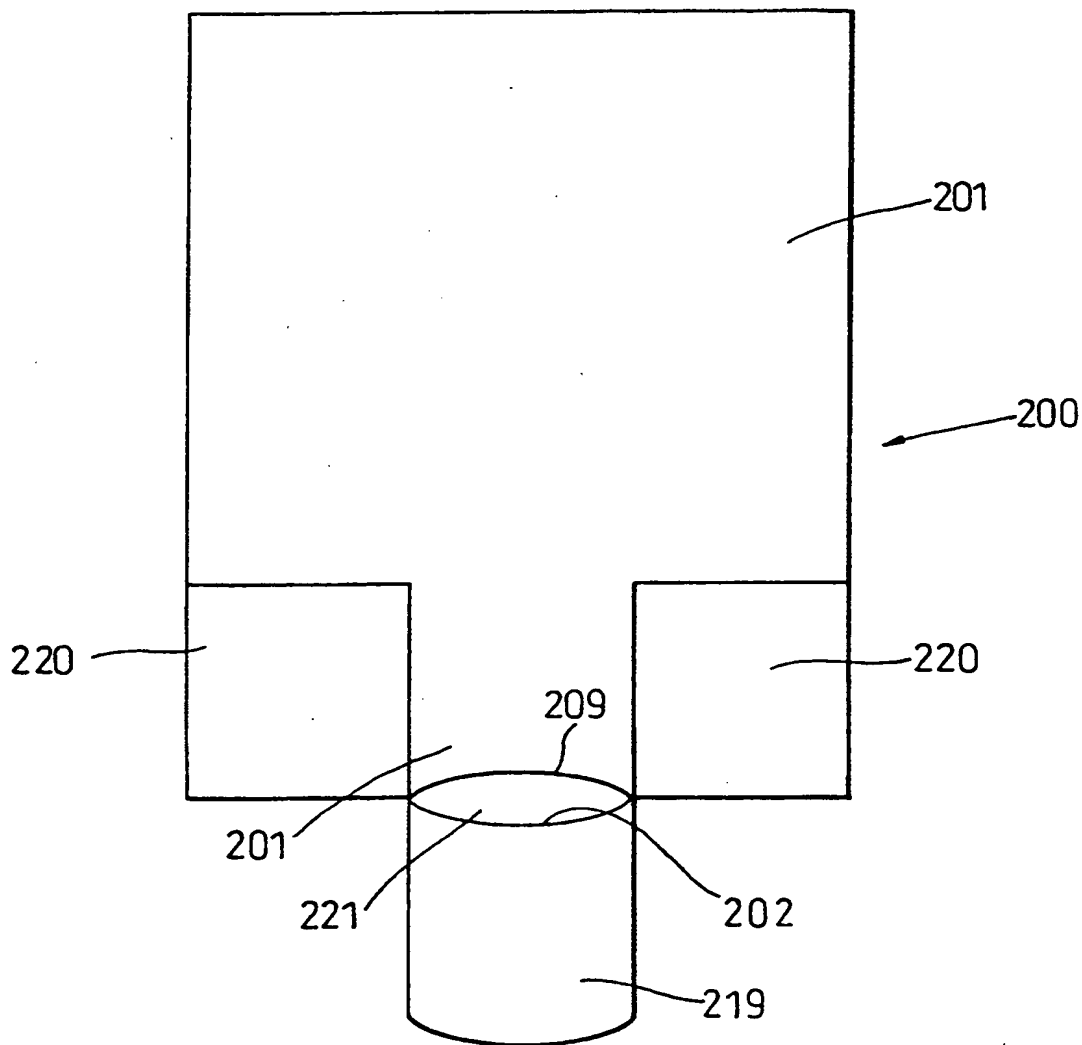
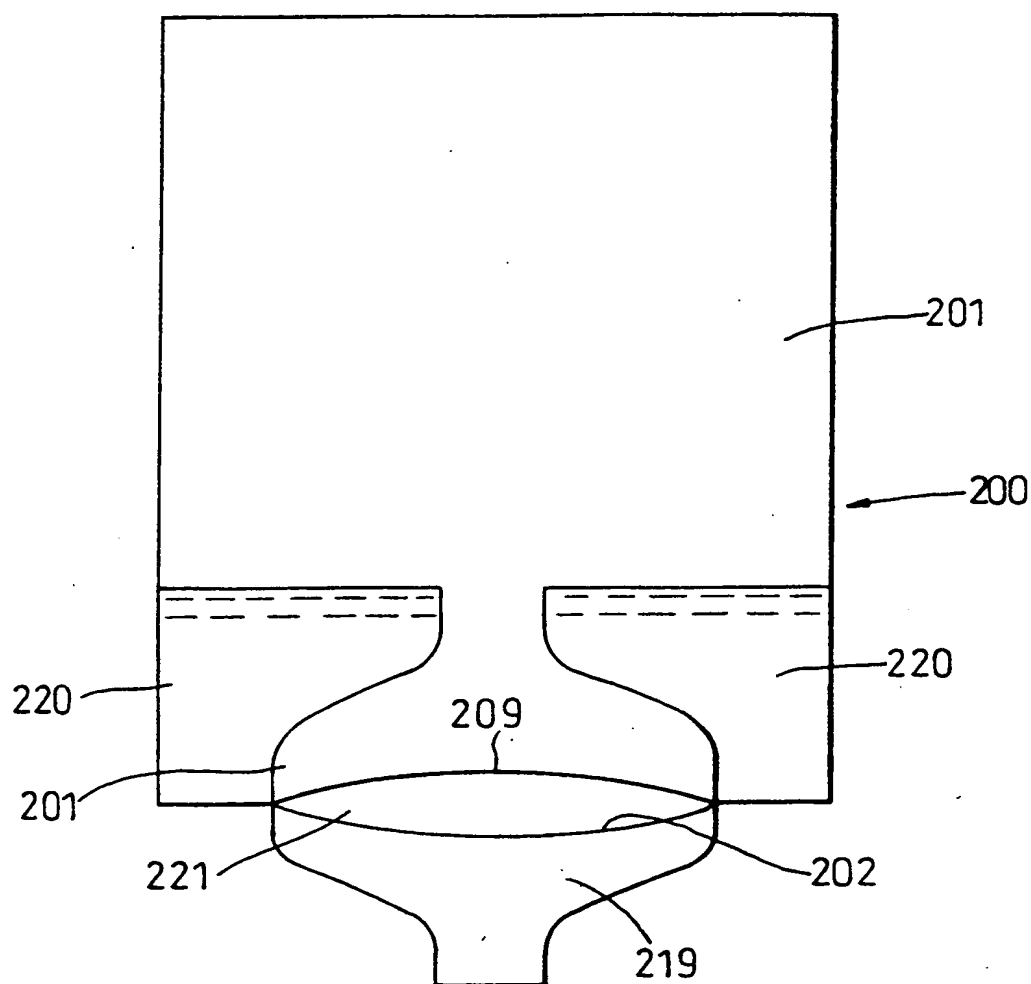


Fig. 9

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**Fig. 10**



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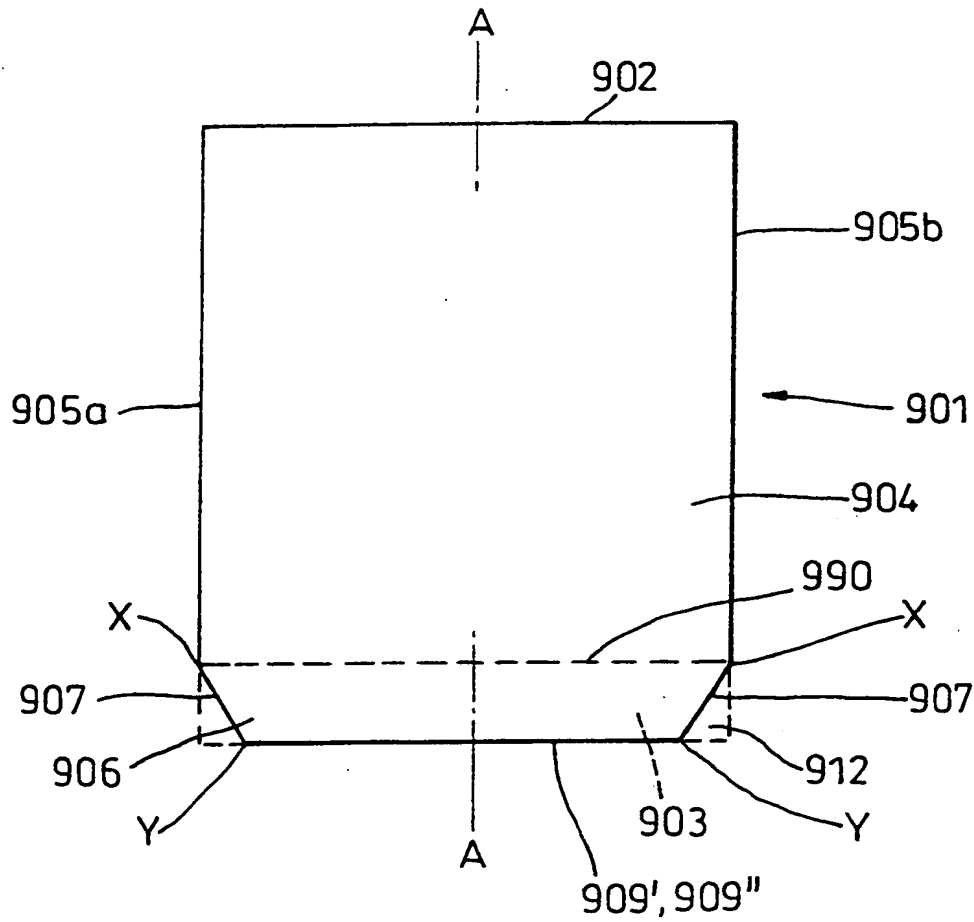


Fig. 13

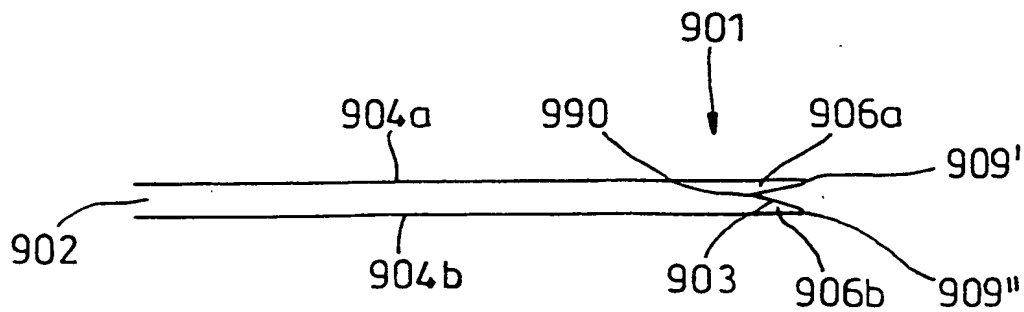
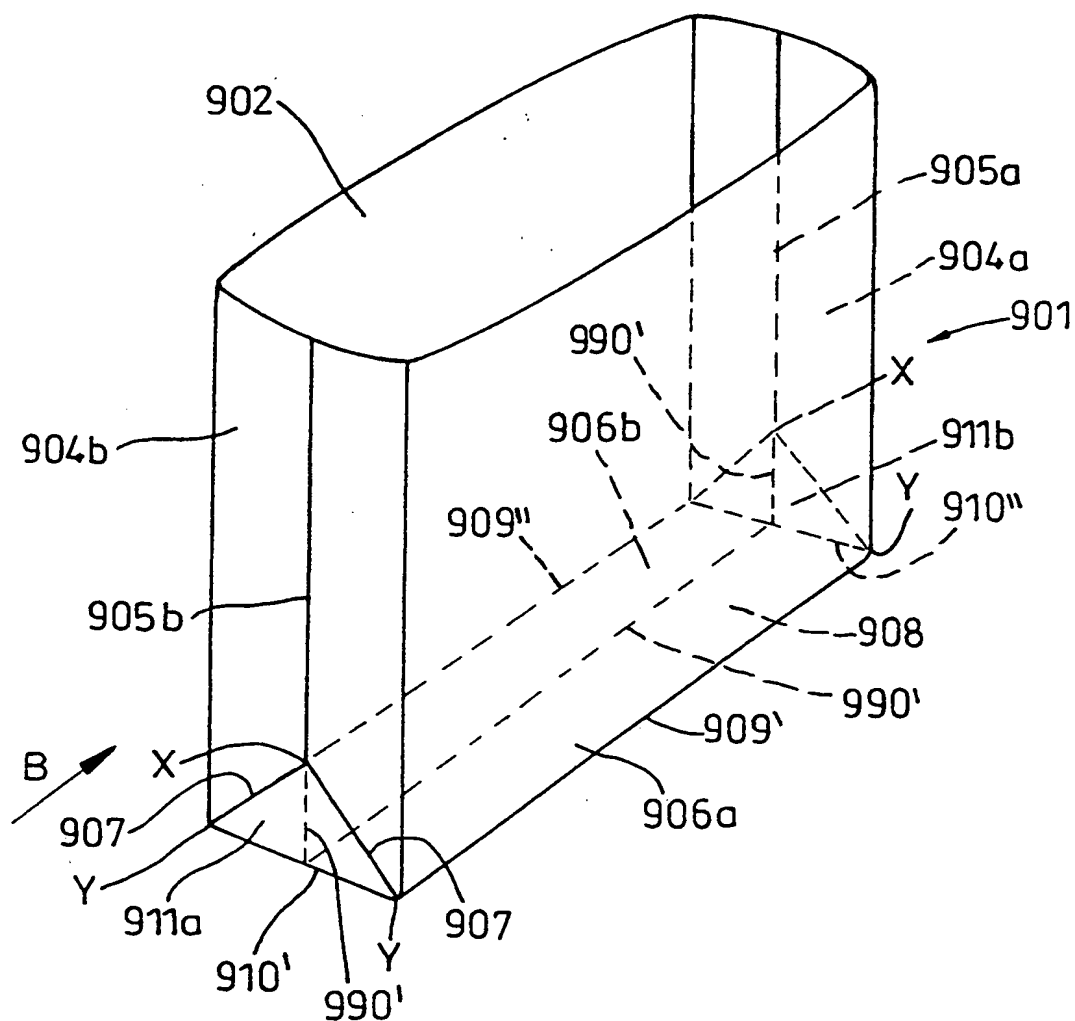


Fig. 14

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*Fig. 15*

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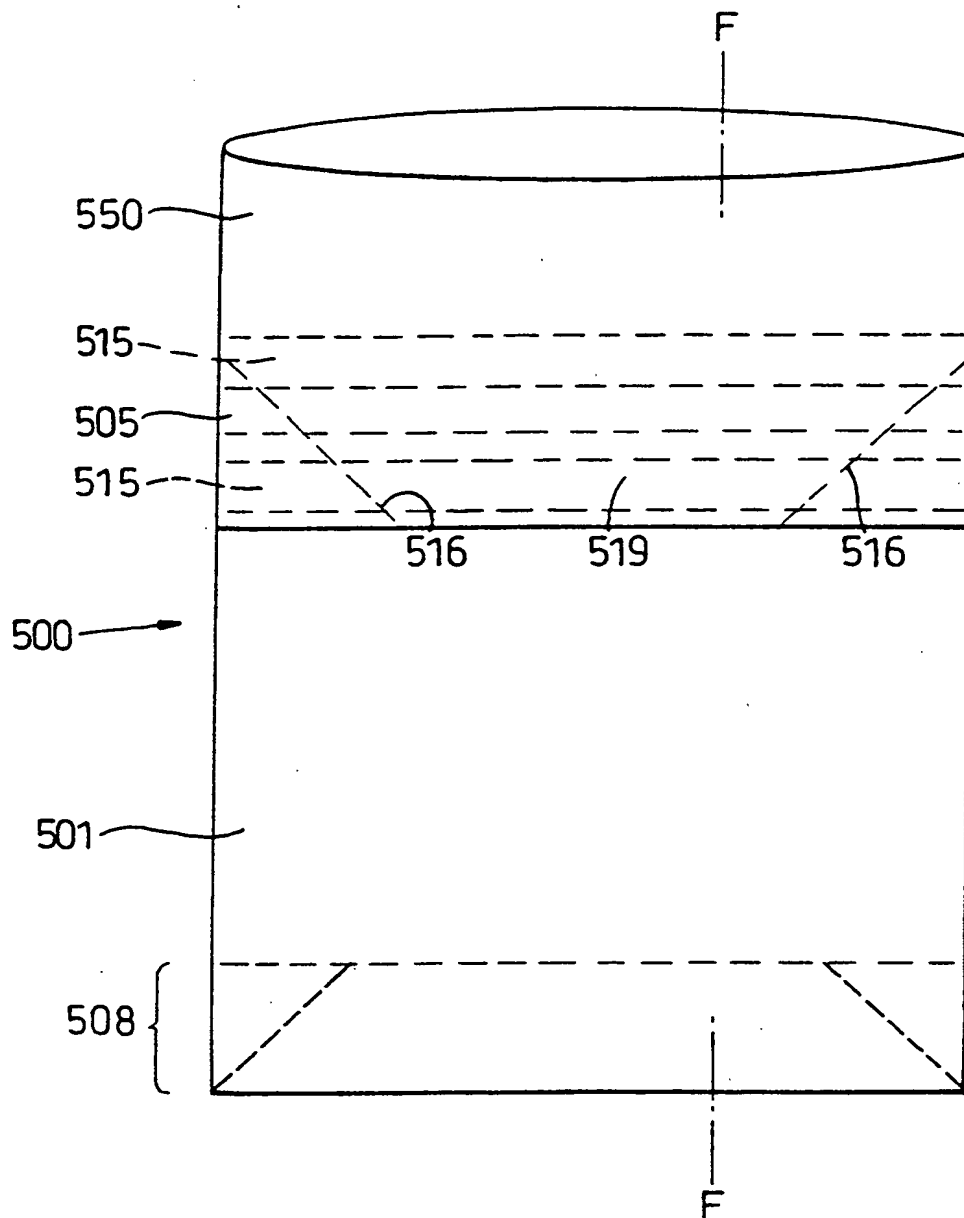


Fig. 16

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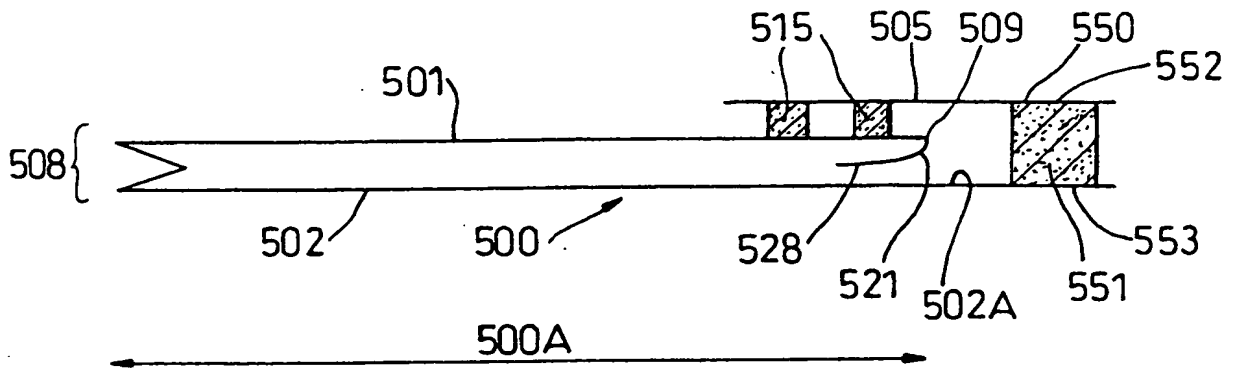


Fig. 17A

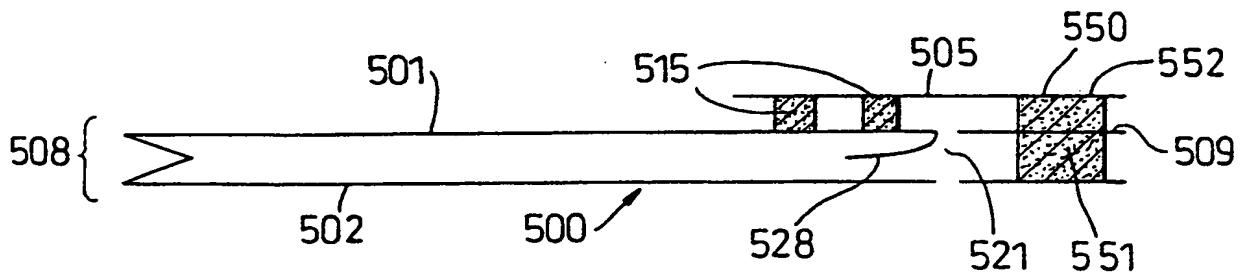


Fig. 17B

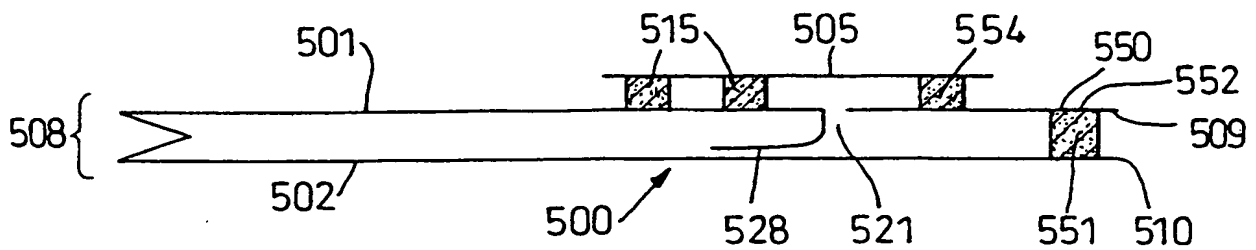
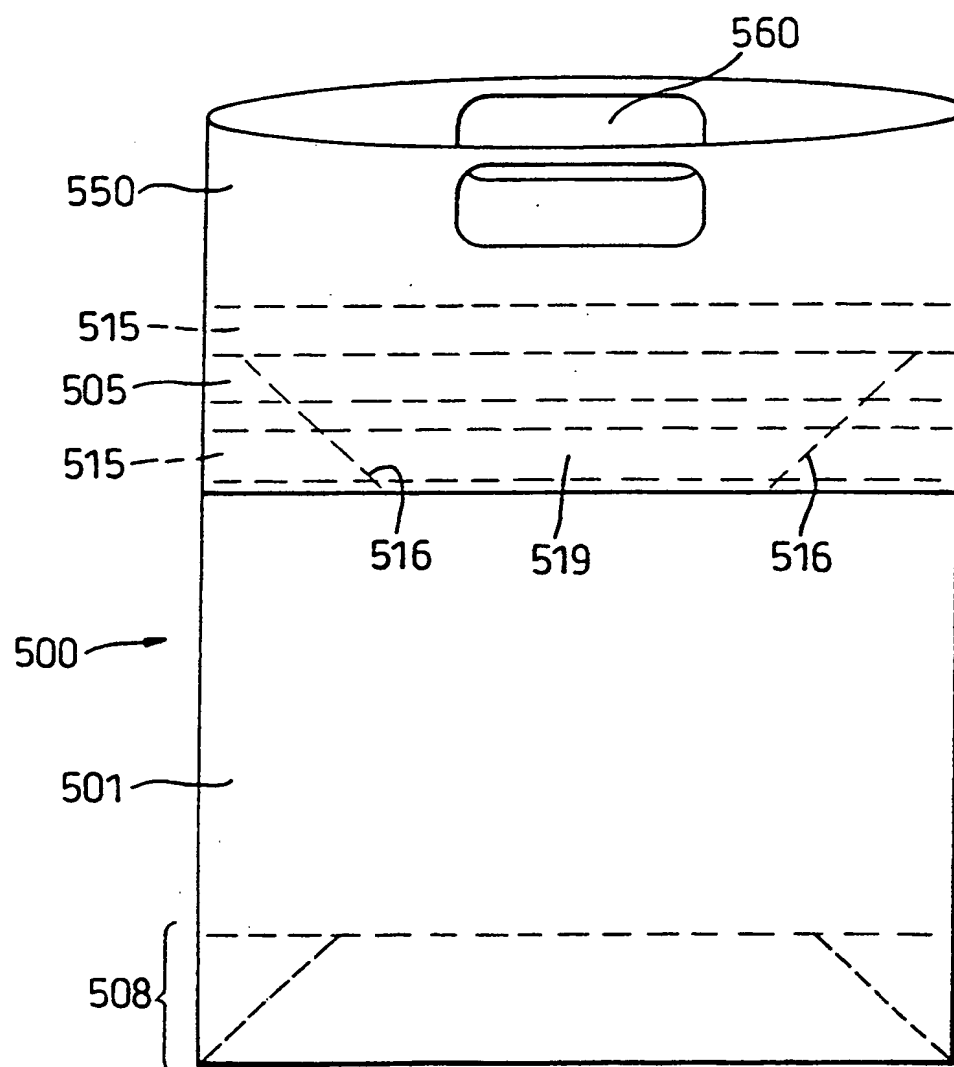


Fig. 17C

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*Fig. 18*

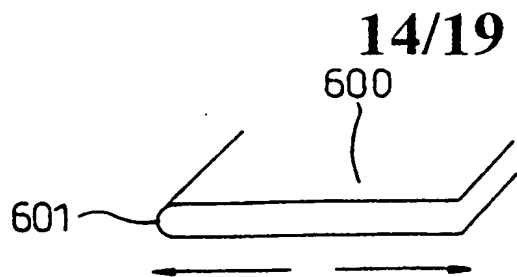


Fig. 19A



Fig. 19B

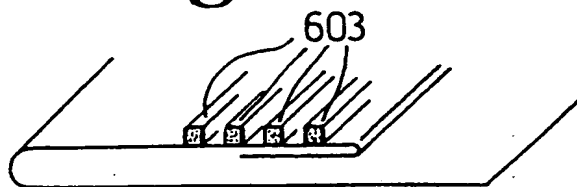


Fig. 19C

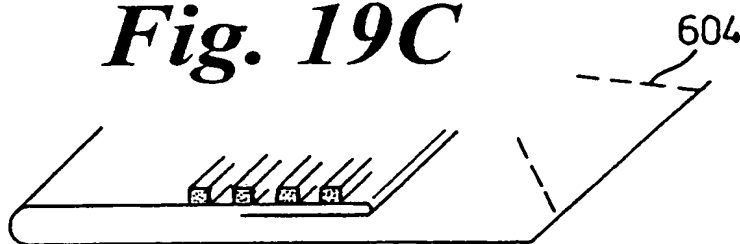


Fig. 19D

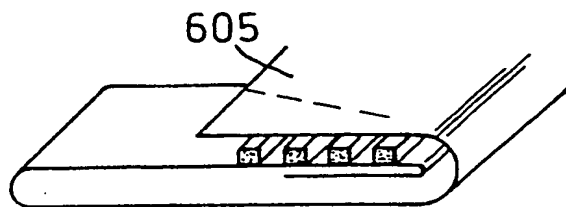


Fig. 19E

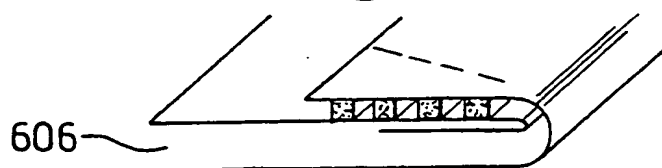


Fig. 19F

700



Fig. 8 is a perspective view of the second embodiment of the device. It shows a similar structure to Fig. 7, with a first layer 701 and a second layer 702. The second layer 702 has a different internal profile compared to the first embodiment, featuring a more pronounced V-shaped notch at the top edge.



-703

704



-716

707



Fig. 20G

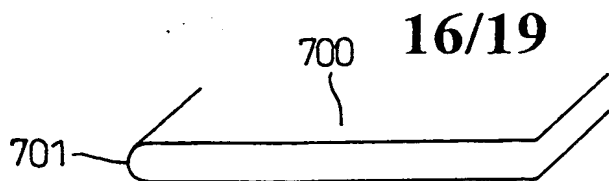


Fig. 21A



Fig. 21B

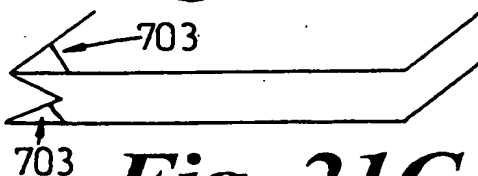


Fig. 21C



Fig. 21D

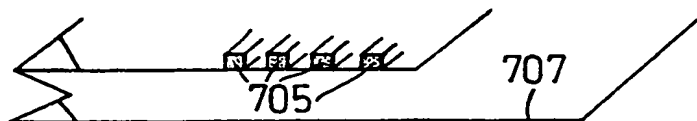


Fig. 21E

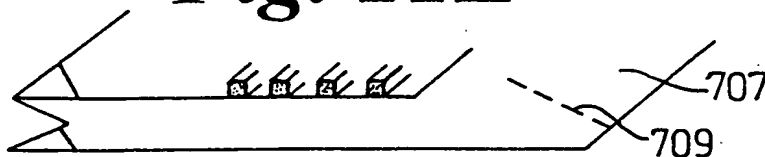


Fig. 21F

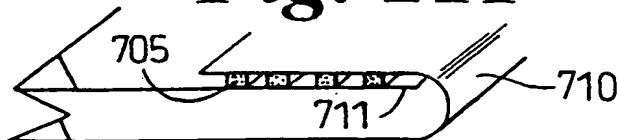


Fig. 21G

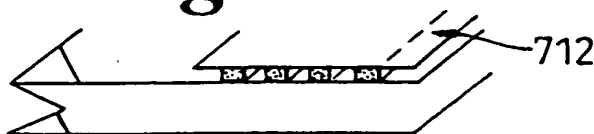
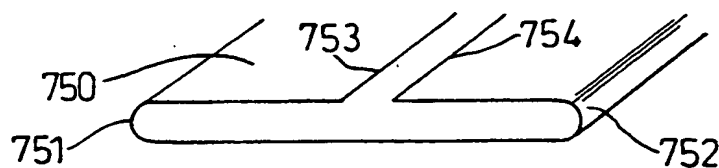
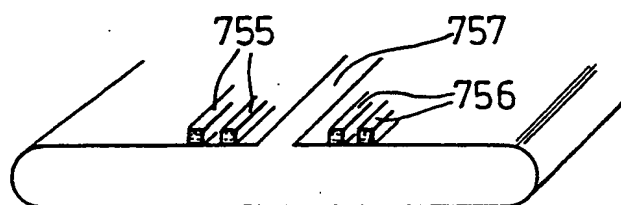
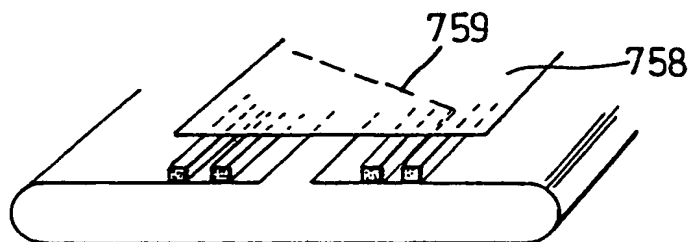
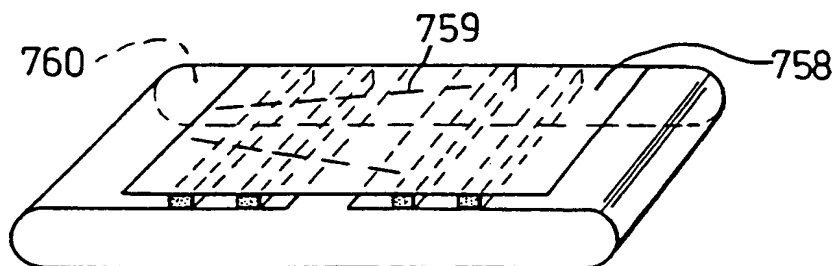
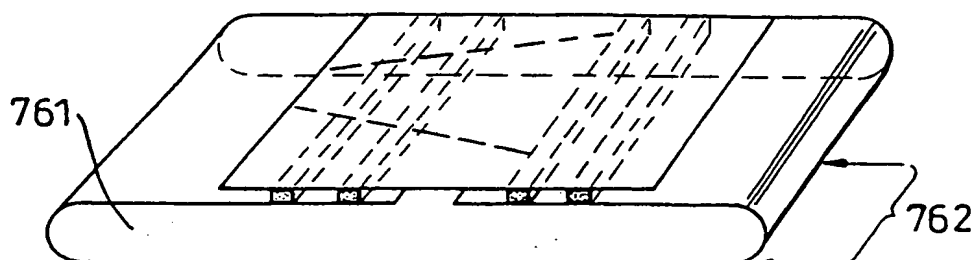


Fig. 21H

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**Fig. 22A****Fig. 22B****Fig. 22C****Fig. 22D****Fig. 22E**

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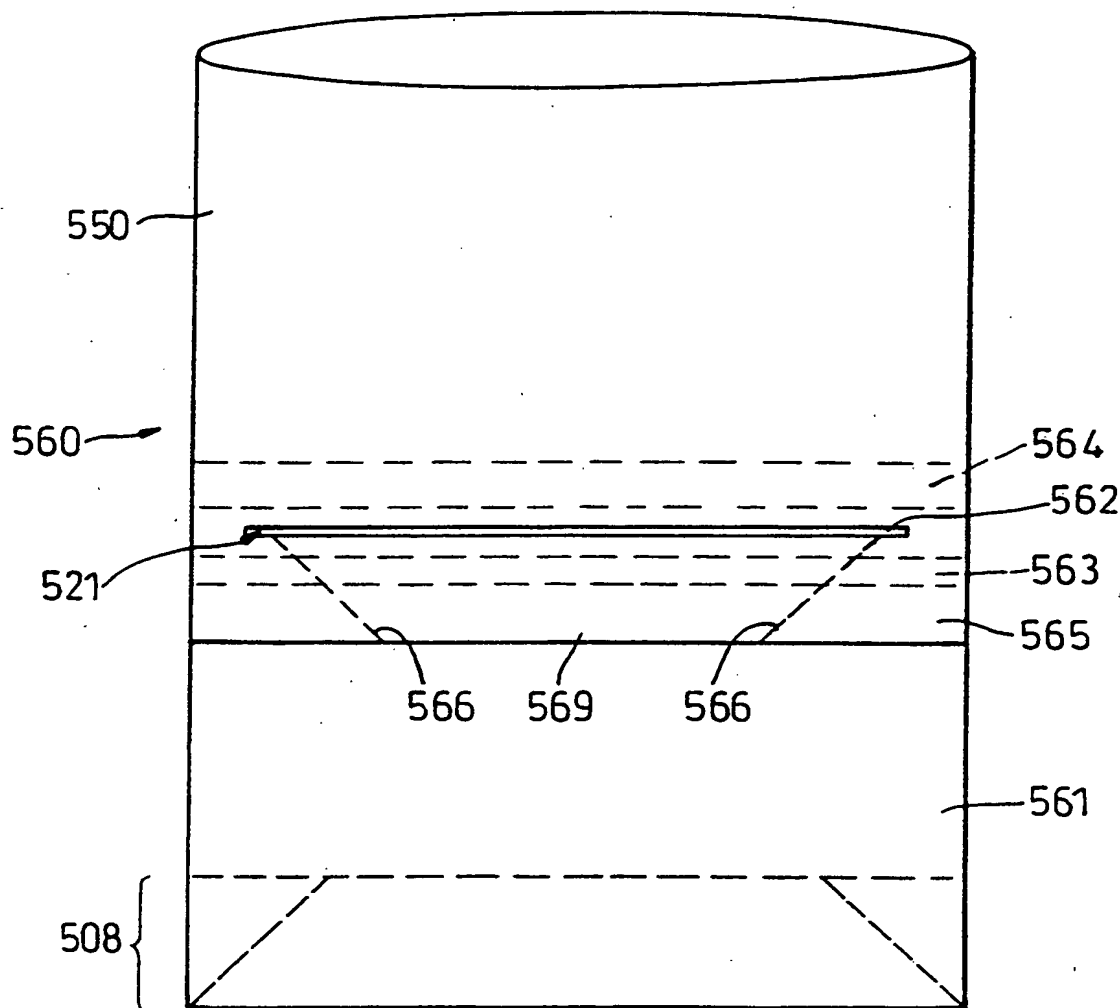


Fig. 23

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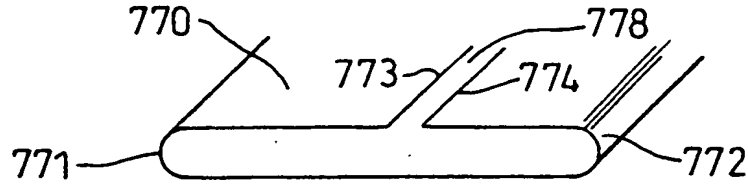


Fig. 24A

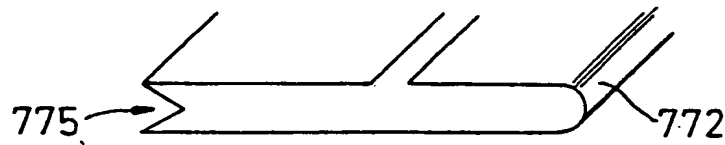


Fig. 24B

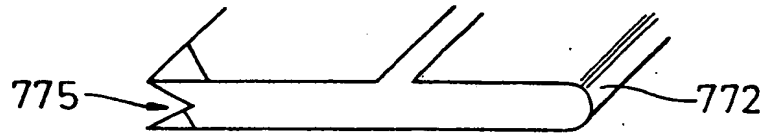


Fig. 24C

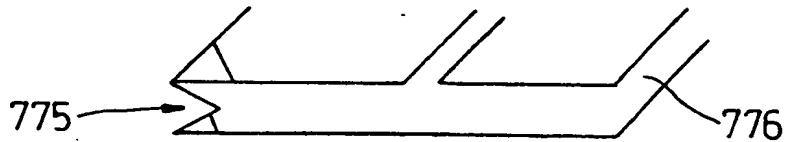


Fig. 24D

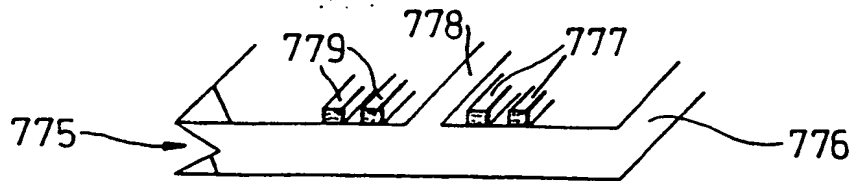


Fig. 24E

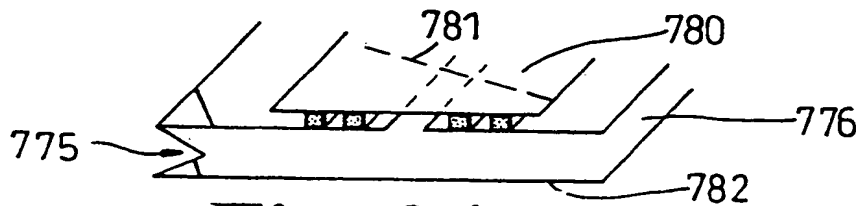


Fig. 24F

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